Photocouplers Photorelay

TLP3545

TLP3545

1. Applications

- Mechanical relay replacements
- Security Systems
- Measuring Equipments
- Factory Automation (FA)
- Amusement Equipments

2. General

The TLP3545 photorelay consists of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 6-pin DIP package. The low ON-state resistance and the high permissible ON-state current of the the TLP3545 make it suitable for power line control applications.

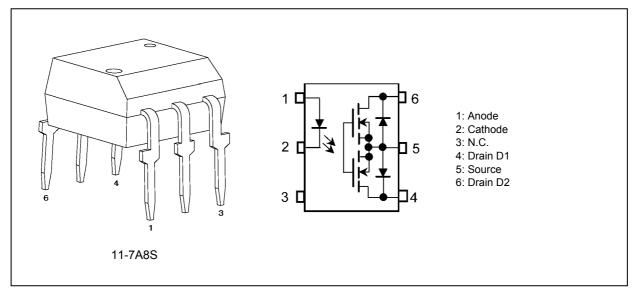
3. Features

- (1) Normally off (1-Form-A)
- (2) OFF-state output terminal voltage: 60 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 3.0 A (max) (A connection)
- (5) ON-state resistance: 70 m Ω (max) (A connection)
- (6) Isolation voltage: 2500 Vrms (min)
- (7) Safety standards

UL-under application: UL1577 File No.E67349

cUL-under application: CSA Component Acceptance Service No.5A, File No.E67349

4. Packaging and Pin Configuration



5. Internal Circuit

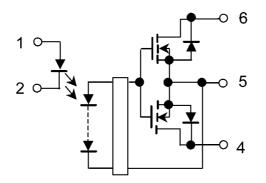


Fig. 5.1 Internal Circuit

6. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25°C)

	Characteristics		Symbol	Note	Rating	Unit
LED	Input forward current		I _F		30	mA
	Input forward current derating	$(T_a \ge 25^{\circ}C)$	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μ s pulse, 100 pps)	I _{FP}		1	A
	Input reverse voltage		V _R		5	V
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage		V _{OFF}		60	V
	ON-state current (A connection)		I _{ON}	(Note 1)	3	А
	ON-state current (B connection)		I _{ON}	(Note 1)	3	
	ON-state current (C connection)	I _{ON}	(Note 1)	6		
	ON-state current derating (A connection)	$(T_a \ge 25^{\circ}C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-30	mA/°C
	ON-state current derating (B connection)	$(T_a \ge 25^{\circ}C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-30	
	ON-state current derating (C connection)	$(T_a \ge 25^{\circ}C)$	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-60	
	ON-state current (pulsed)	(t = 100 ms, Duty = 1/10)	I _{ONP}		9	Α
	Output power dissipation		Po		500	mW
	Junction temperature		Tj		125	°C
Common	Storage temperature		T _{stg}		-55 to 125	
	Operating temperature		T _{opr}		-40 to 85	
	Lead soldering temperature	(10 s)	T _{sol}		260	
	Isolation voltage	AC, 1 min, R.H. ≤ 60%	BVS	(Note 2)	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For an application circuit example, see Fig. 12.2.

Note 2: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		_	—	48	V
Input forward current	١ _F		5	10	25	mA
ON-state current (A connection)	I _{ON}		_	_	3	А
Operating temperature	T _{opr}		-20		65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

8. Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}$ C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.18	1.33	1.48	V
	Input reverse current	I _R		V _R = 5 V	—		10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	70	_	pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 60 V	_	_	1	μA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	_	1000	_	pF

9. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 1.0 A	_	0.5	3	mA
Return LED current	I _{FC}		I _{OFF} = 10 μA	0.1			mA
ON-state resistance (A connection)	R _{ON}	(Note 1)	I _{ON} = 2.0 A, I _F = 5 mA, t < 1 s	_	40	70	mΩ
ON-state resistance (B connection)				_	20	_	
ON-state resistance (C connection)			I _{ON} = 4.0 A, I _F = 5 mA, t < 1 s	_	10		

Note 1: For an application circuit example, see Fig. 12.2.

10. Isolation Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz	_	0.8	—	pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. $\leq 60\%$	$5 imes 10^{10}$	1014	_	Ω
Isolation voltage	BVS		AC, 1 min	2500	_	—	Vrms
			AC, 1s in oil	_	5000	_	
			DC, 1 min, in oil	_	5000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

11. Switching Characteristics (Unless otherwise specified, $T_a = 25^{\circ}C$)

Characteristics	Symbol	Note	Test Condition	Min	Тур	Max	Unit
Turn-on time	t _{ON}		See Fig. 11.1.	—	2	5	ms
Turn-off time	t _{OFF}		R _L = 200 Ω, V _{DD} = 20 V, I _F = 5 mA	_	0.1	1	
Turn-on time	t _{ON}		See Fig. 11.1.	_	1	3	
Turn-off time	t _{OFF}		R _L = 200 Ω, V _{DD} = 20 V, I _F = 10 mA		0.1	1	

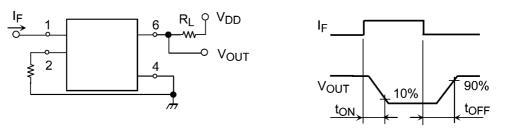
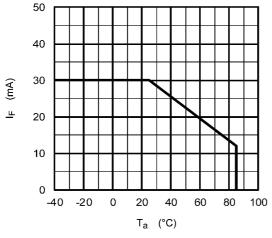
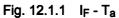


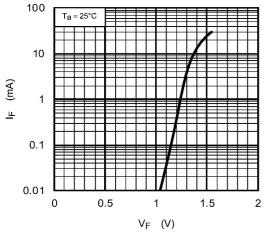
Fig. 11.1 Switching Time Test Circuit

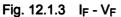
12. Characteristics Curves and Circuit Connections

12.1. Characteristics Curves (Note)









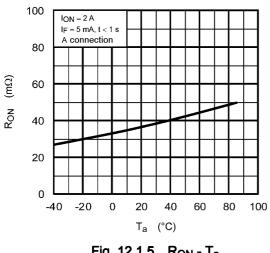


Fig. 12.1.5 RON - Ta

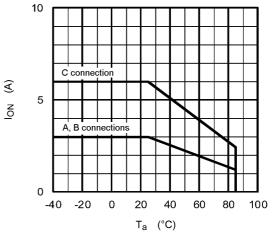


Fig. 12.1.2 ION - Ta

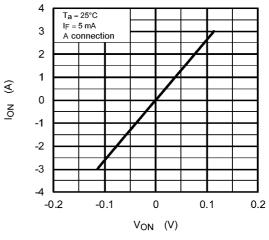


Fig. 12.1.4 ION - VON

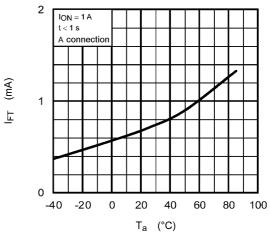
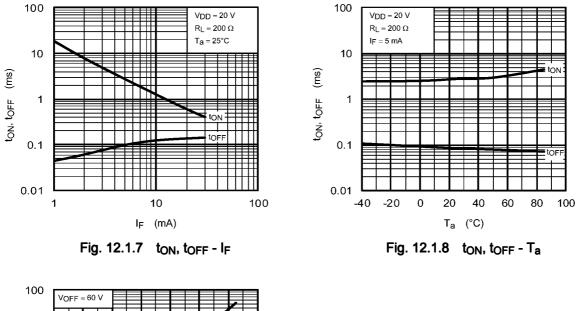
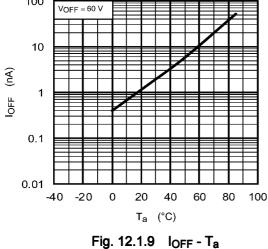


Fig. 12.1.6 IFT - Ta





Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



12.2. Circuit Connections

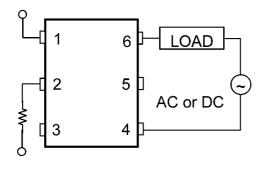
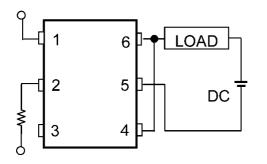


Fig. 12.2.1 A Connection





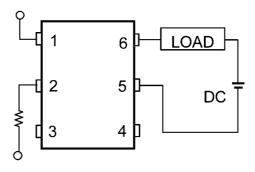
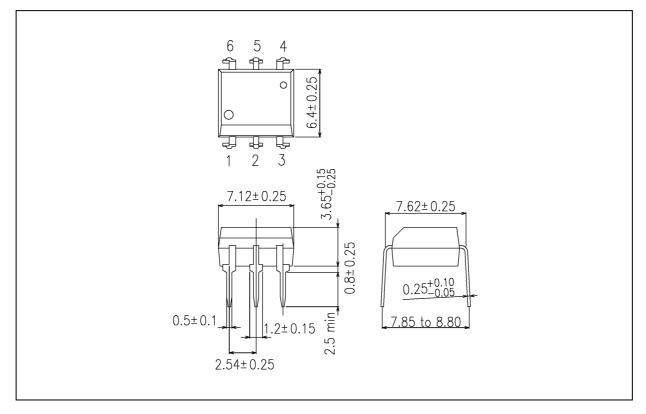


Fig. 12.2.2 B Connection

TLP3545

Package Dimensions

Unit: mm



Weight: 0.4 g (typ.)

	Package Name(s)
TOSHIBA: 11-7A8S	

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